

7 CIRCUIT DARLINGTON TRANSISTOR ARRAY

FEATURES

- Output Current : 500mA Max.
- High Sustaining Voltage Outputs : 50V Min.
- Output Clamp Diodes
- Inputs Compatible With Various Types of Logic.
- PKG Type AP : DIP-16Pin, AF : FLP-16Pin

| TYPE | INPUT RESISTOR | DESIGNATION |
|---------------|--------------------------|--------------------|
| KID65001AP/AF | No (External) | General Purpose |
| KID65002AP/AF | Zener Diode 7V+10.5kΩ | 14~25V P-MOS |
| KID65003AP/AF | 2.7kΩ | TTL, 5V C-MOS |
| KID65004AP/AF | 10.5kΩ | 6~15V P-MOS, C-MOS |

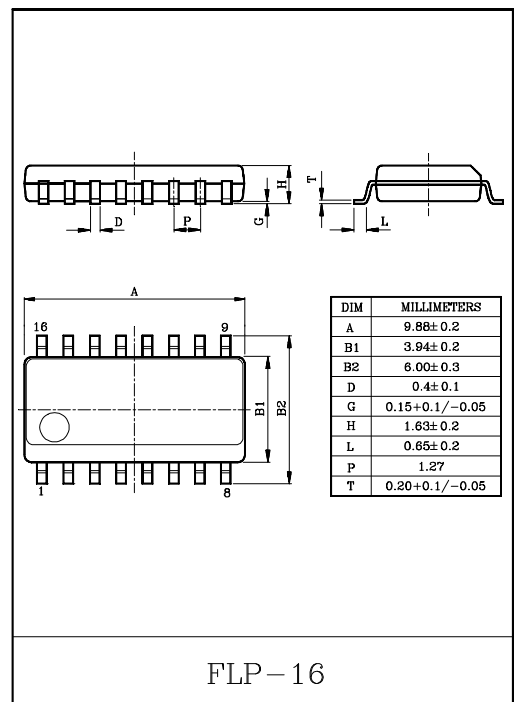
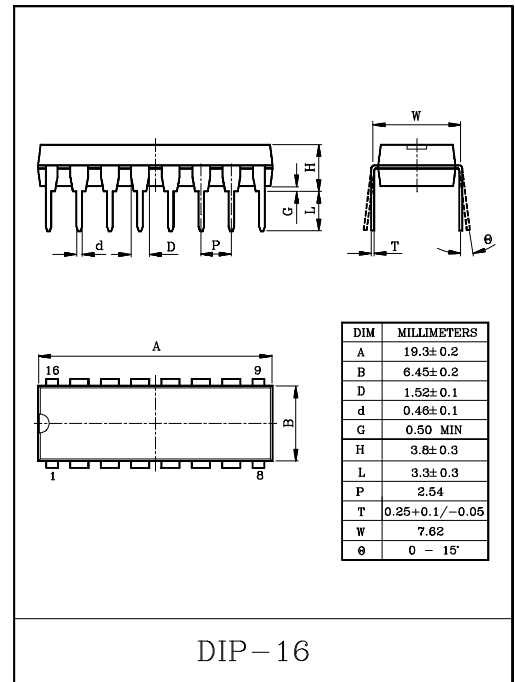
DESCRIPTION:

The KID65001AP/AF Series are high-voltage, high-current darlington transistor array comprised of seven NPN darlington pairs. All units feature internal clamp diodes for switching inductive loads.

MAXIMUM RATINGS (Ta=25°C, unless otherwise noted)

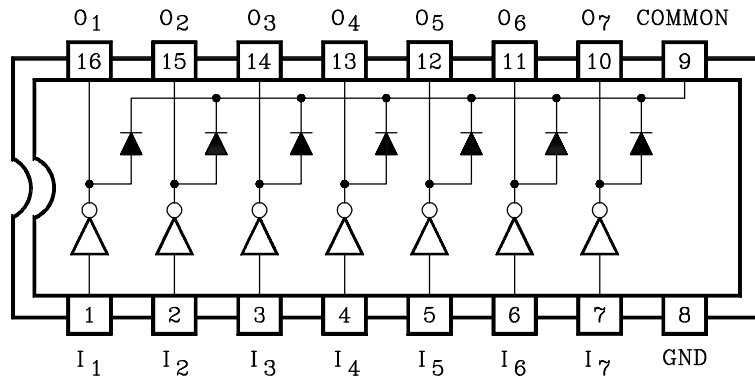
| CHARACTERISTIC | | SYMBOL | RATING | UNIT |
|---------------------------|-----------------|---------------|----------|------|
| Output Sustaining Voltage | | $V_{CE(SUS)}$ | 50 | V |
| Output Current | | I_{OUT} | 500 | mA |
| Input Voltage | | V_{IN}^* | -0.5~+30 | V |
| Input Current | | I_{IN}^{**} | 25 | mA |
| Clamp Diode | Reverse Voltage | V_R | 50 | V |
| | Forward Current | I_F | 500 | mA |
| GND Terminal Current | | I_{GND} | 2.8 | A |
| Power Dissipation | AP | P_D | 1.47 | W |
| | AF | | 0.54 | W |
| Operating Temperature | | T_{opr} | -40~85 | °C |
| Storage Temperature | | T_{stg} | -55~150 | °C |

*Except KID65001AP/AF, **Only KID65001AP/AF



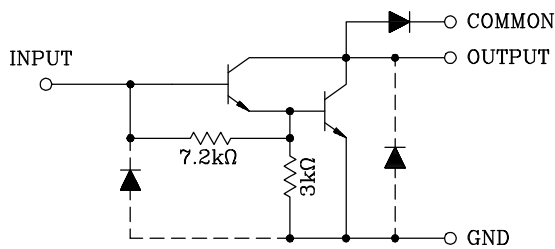
KID65001AP/AF ~ KID65004AP/AF

PIN CONNECTION (TOP VIEW)

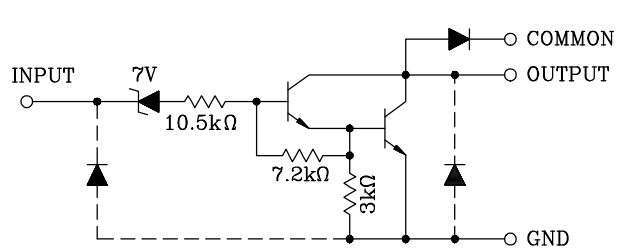


SCHEMATICS (EACH DRIVER)

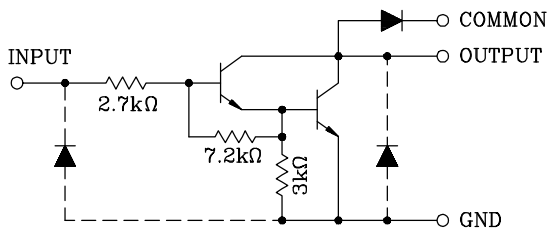
KID65001AP/AF



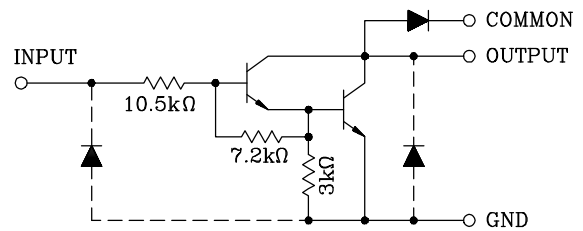
KID65002AP/AF



KID65003AP/AF



KID65004AP/AF



KID65001AP/AF ~ KID65004AP/AF

RECOMMENDED OPERATING CONDITIONS (Ta=-40~85°C)

| CHARACTERISTIC | | SYMBOL | CONDITION | MIN. | TYP. | MAX. | UNIT |
|-----------------------------|----|----------------------|---|------|------|------|------|
| Output Sustaining Voltage | | V _{CE(SUS)} | | 0 | - | 50 | V |
| Output Current | | I _{OUT} | T _{PW} =25ms, DF=10%, 7 Circuits | 0 | - | 400 | mA |
| | | | T _{PW} =25ms, DF=30%, 7 Circuits | 0 | - | 200 | |
| Input Voltage | | V _{IN} | Except KID65001AP/AF | 0 | - | 30 | V |
| Input Current | | I _{IN} | Only KID65001AP/AF | 0 | - | 5 | mA |
| Clamp Diode Reverse Voltage | | V _R | | - | - | 50 | V |
| Clamp Diode Forward Current | | I _F | | - | - | 400 | mA |
| Power Dissipation | AP | P _D | Ta=Topr(max) * | - | - | 0.52 | W |
| | AF | | | - | - | 0.32 | |

* : on glass epoxy PCB (30×30×1.6mm Cu50%)

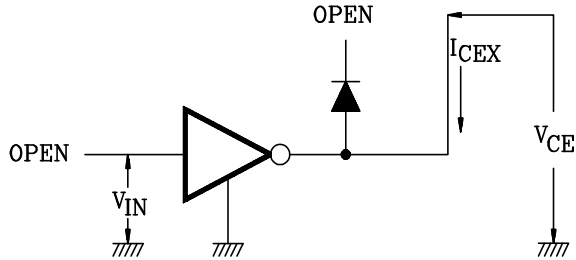
ELECTRICAL CHARACTERISTICS (Ta=25°C, unless otherwise noted)

| CHARACTERISTICS | | SYMBOL | TEST CIRCUIT | TEST CONDITION | MIN. | TYP. | MAX. | UNIT |
|--------------------------------------|--|----------------------|----------------------------------|---|------|------|------|------|
| Output Leak Current | | I _{CEX} | 1 | V _{CE} =50V, Ta=25°C | - | - | 50 | μA |
| | | | | V _{CE} =50V, Ta=85°C | - | - | 100 | |
| | KID65002AP/AF | | | V _{CE} =50V, V _{IN} =6V | - | - | 500 | |
| | KID65004AP/AF | | | V _{CE} =50V, V _{IN} =1V | - | - | 500 | |
| Collector-Emitter Saturation Voltage | | V _{CE(sat)} | 2 | I _{OUT} =350mA, I _{IN} =500μA | - | 1.3 | 1.6 | V |
| | | | | I _{OUT} =200mA, I _{IN} =350μA | - | 1.1 | 1.3 | |
| | | | | I _{OUT} =100mA, I _{IN} =250μA | - | 0.9 | 1.1 | |
| Input Current | KID65002AP/AF | I _{IN(ON)} | 3 | V _{IN} =17V | - | 0.82 | 1.25 | mA |
| | KID65003AP/AF | | | V _{IN} =3.85V | - | 0.93 | 1.35 | |
| | KID65004AP/AF | | | V _{IN} =5V | - | 0.35 | 0.5 | |
| | | | | V _{IN} =12V | - | 1.0 | 1.45 | |
| | I _{IN(OFF)} | 4 | I _{OUT} =500μA, Ta=85°C | 50 | 65 | - | μA | |
| Input Voltage | KID65002AP/AF | V _{IN(ON)} | 5 | V _{CE} =2V, I _{OUT} =300mA | - | - | 13 | V |
| | KID65003AP/AF | | | V _{CE} =2V, I _{OUT} =200mA | - | - | 2.4 | |
| | | | | V _{CE} =2V, I _{OUT} =250mA | - | - | 2.7 | |
| | KID65004AP/AF | | | V _{CE} =2V, I _{OUT} =300mA | - | - | 3.0 | |
| | | | | V _{CE} =2V, I _{OUT} =125mA | - | - | 5.0 | |
| | | | | V _{CE} =2V, I _{OUT} =200mA | - | - | 6.0 | |
| | | | | V _{CE} =2V, I _{OUT} =275mA | - | - | 7.0 | |
| | V _{CE} =2V, I _{OUT} =350mA | - | - | 8.0 | | | | |
| DC Current Transfer Ratio | | h _{FE} | 2 | V _{CE} =2V, I _{OUT} =350mA | 1000 | - | - | |
| Clamp Diode Reverse Current | | I _R | 6 | V _R =50V, Ta=25°C | - | - | 50 | μA |
| | | | | V _R =50V, Ta=85°C | - | - | 100 | |
| Clamp Diode Forward Voltage | | V _F | 7 | I _F =350mA | - | - | 2.0 | V |
| Input Capacitance | | C _{IN} | | | - | 15 | - | pF |
| Turn-ON Delay | | t _{ON} | 8 | V _{OUT} =50V, R _L =163Ω C _L =15pF | - | 0.1 | - | μS |
| Turn-OFF Delay | | t _{OFF} | | | - | 0.2 | - | |

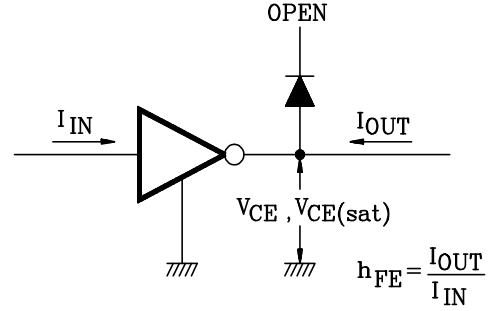
KID65001AP/AF ~ KID65004AP/AF

TEST CIRCUIT

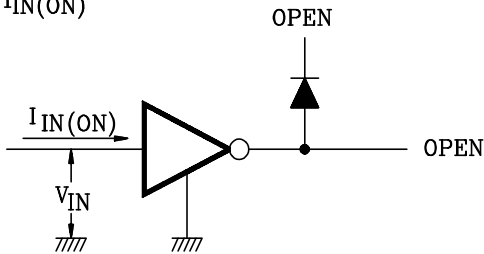
1. I_{CEX}



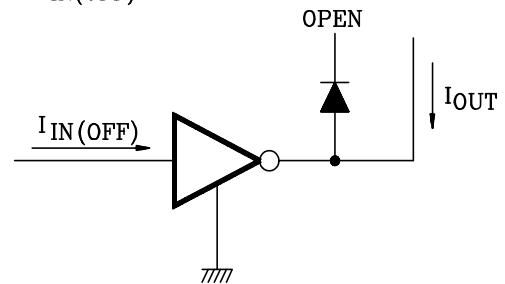
2. $V_{CE(sat)}$, h_{FE}



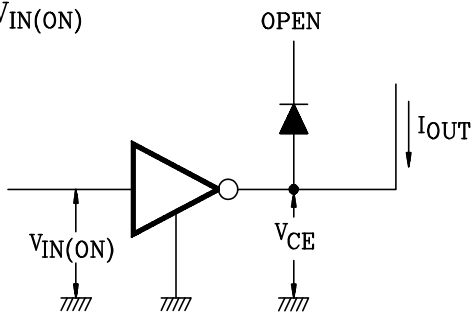
3. $I_{IN(ON)}$



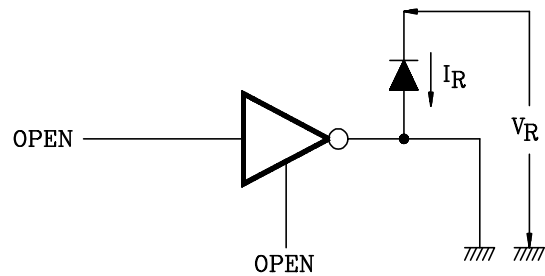
4. $I_{IN(OFF)}$



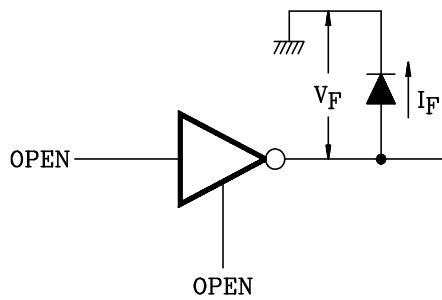
5. $V_{IN(ON)}$



6. I_R

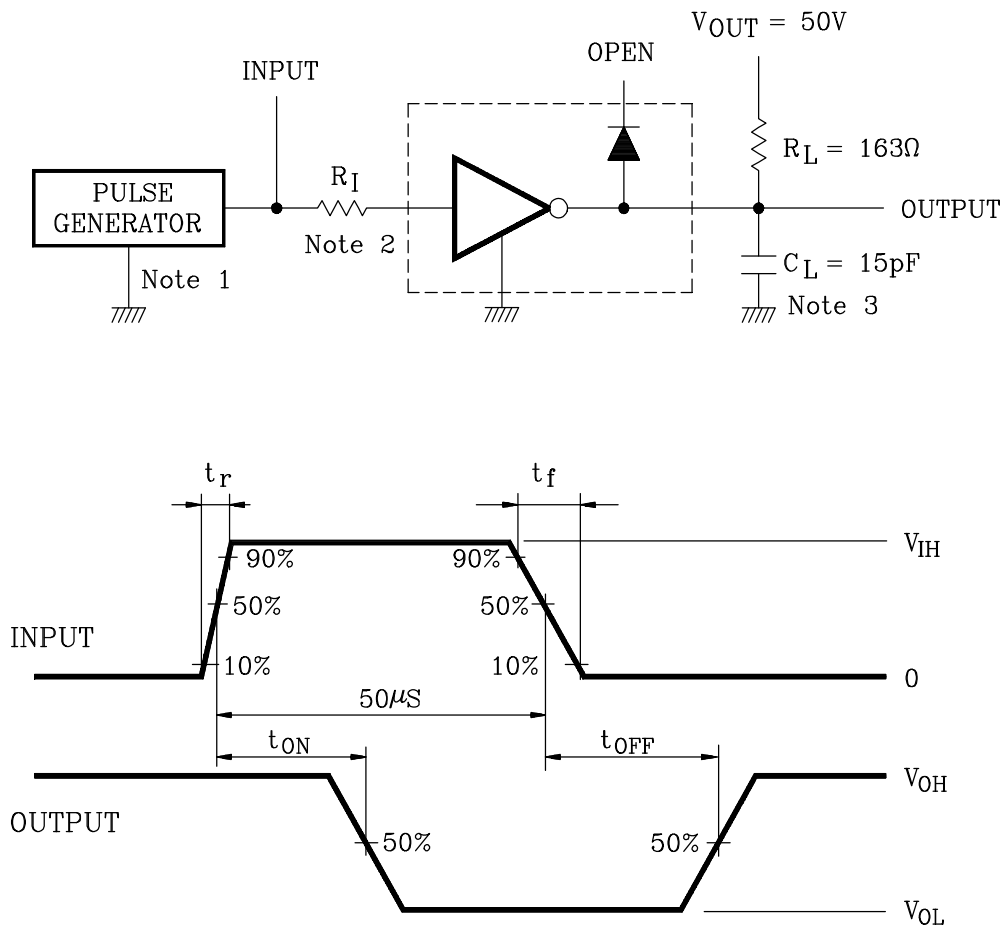


7. V_F



KID65001AP/AF ~ KID65004AP/AF

8. t_{ON}, t_{OFF}



Notes : 1. Pulse Width $50\mu\text{s}$, Duty Cycle 10%
Output Impedance 50Ω , $t_r \leq 5\text{ns}$, $t_f \leq 10\text{ns}$

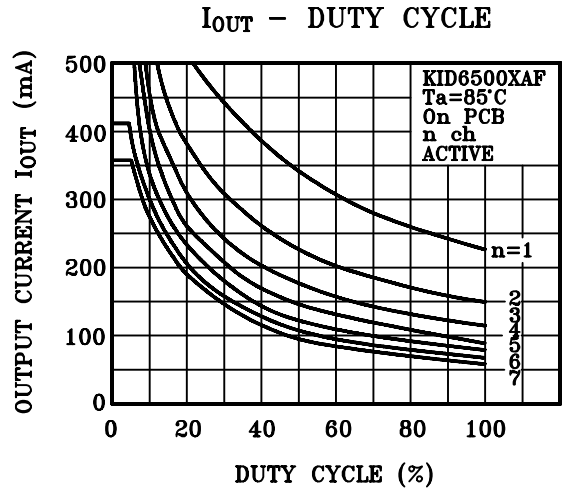
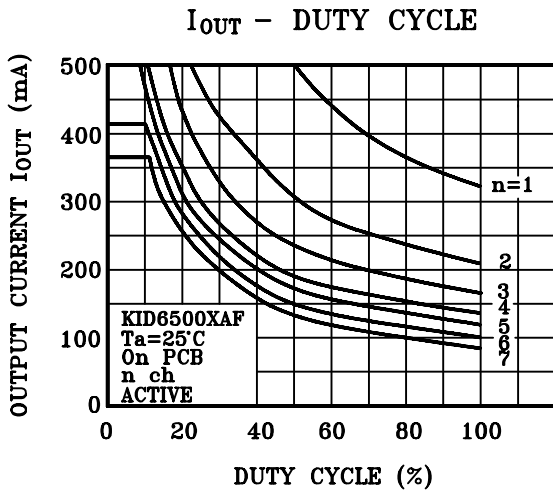
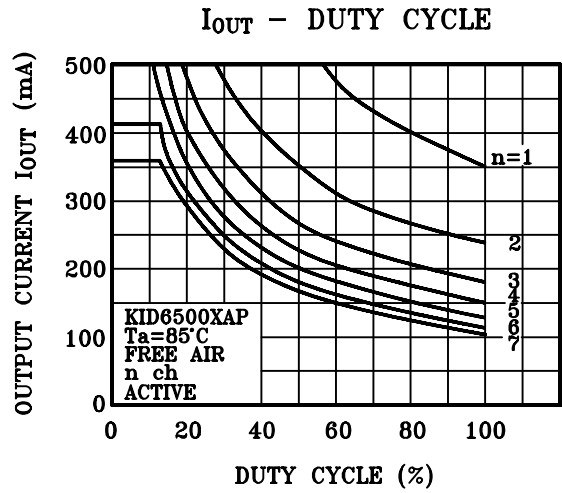
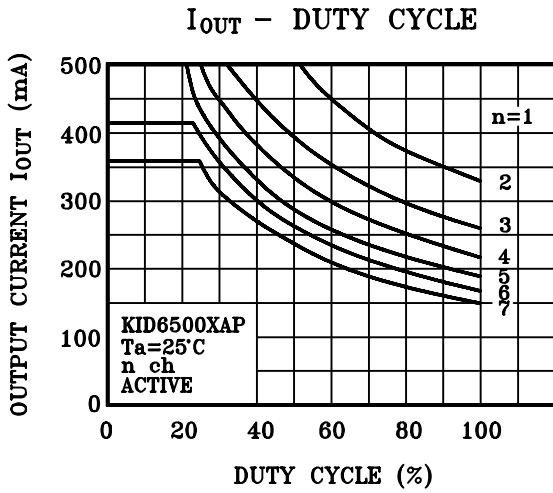
2. See below

Input Conditions

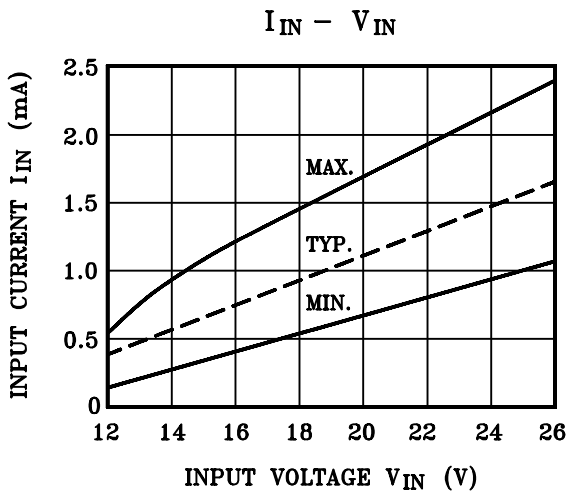
| Type Number | R_I | V_{IH} |
|---------------|---------------------|----------|
| KID65001AP/AF | $2.7\text{k}\Omega$ | 3V |
| KID65002AP/AF | 0 | 13V |
| KID65003AP/AF | 0 | 3V |
| KID65004AP/AF | 0 | 8V |

3. C_L includes probe and Jig capacitance.

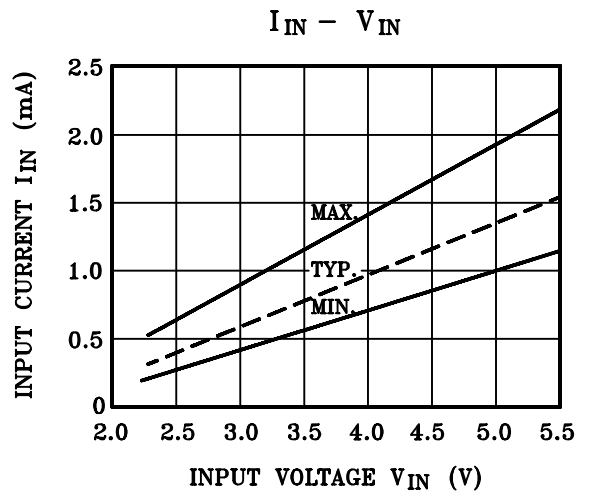
KID65001AP/AF ~ KID65004AP/AF



KID65002AP/AF



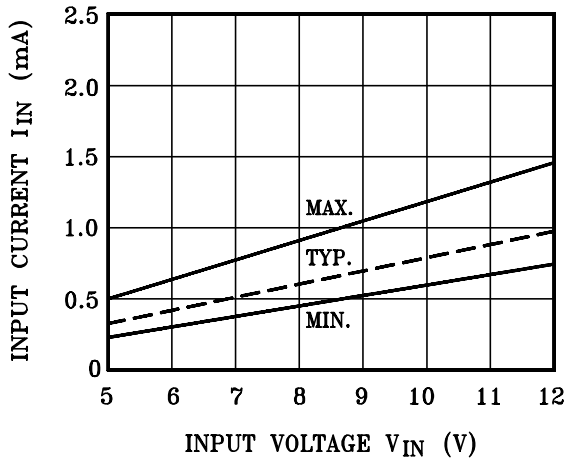
KID65003AP/AF



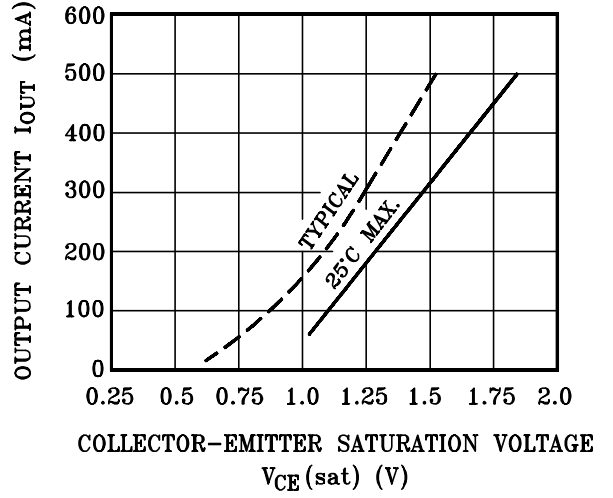
KID65001AP/AF ~ KID65004AP/AF

KID65004AP/AF

$I_{IN} - V_{IN}$



$I_{OUT} - V_{CE(sat)}$



$P_D - T_a$

